## DEC Chip Design Contest



# A Sub-THz SiGe DHBT Power Amplifier Using Slotline-based Power Combiner



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#### Introduction

#### Advantages of the THz Band:

- The wide frequency range enables the development of ultra-high-speed wireless communication systems.
- The THz band is suitable for various applications, such as radar, imaging systems, and optical signal processing.

#### The needs of power amplifier (PA)

- To enable the aforementioned applications, a high-output power source is necessary.
- There is a need for low-loss and wideband power combining structures to enhance the power output.

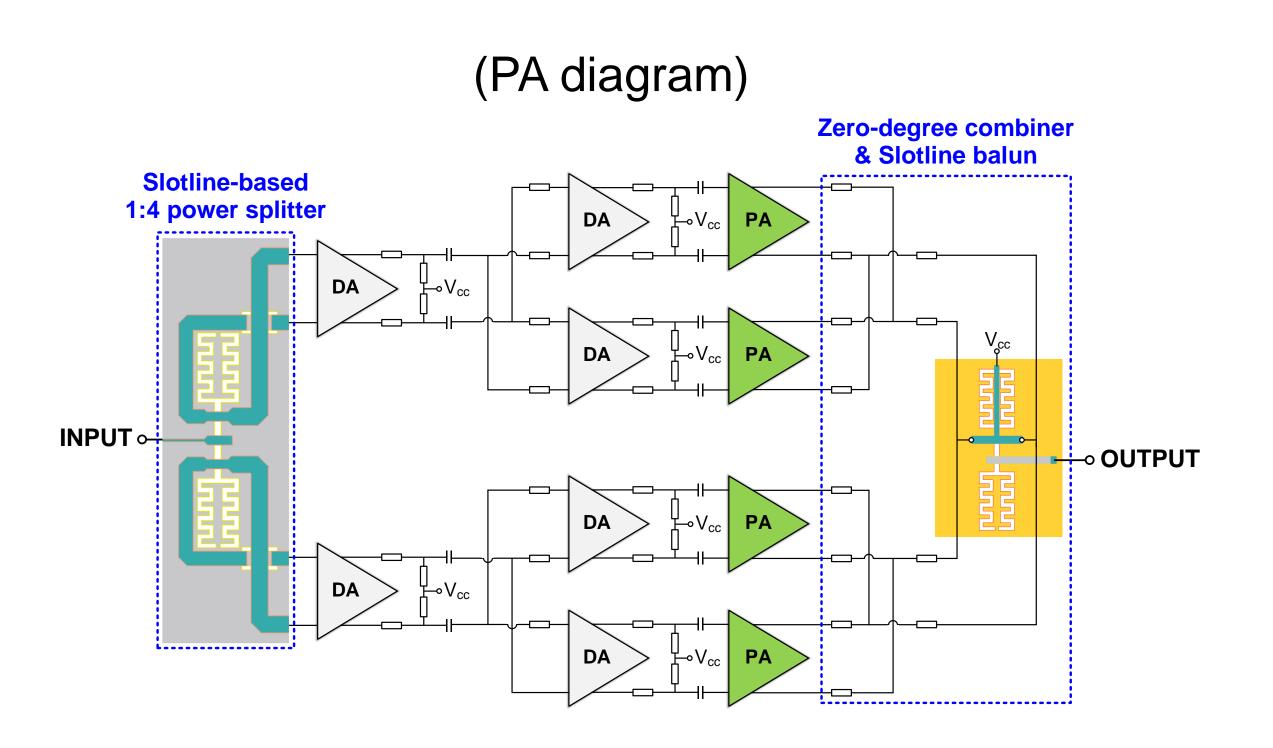
### Design

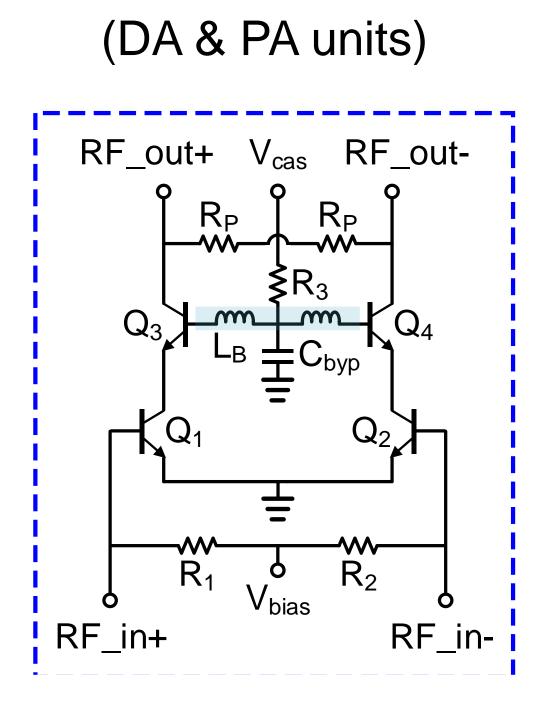
#### Output matching network design

- The slotline-based balun is designed to effectively minimize the imbalance of differential signals by removing the evenmode components. This addresses issues such as oscillation and gain reduction that can occur in differential circuits.
- Slotline-based 1:4 power splitter with extra insertion loss of 0.8–1.7 dB over the range of 160–280 GHz.
- Zero-degree combiner is used for output matching and power combining.

#### PA core design

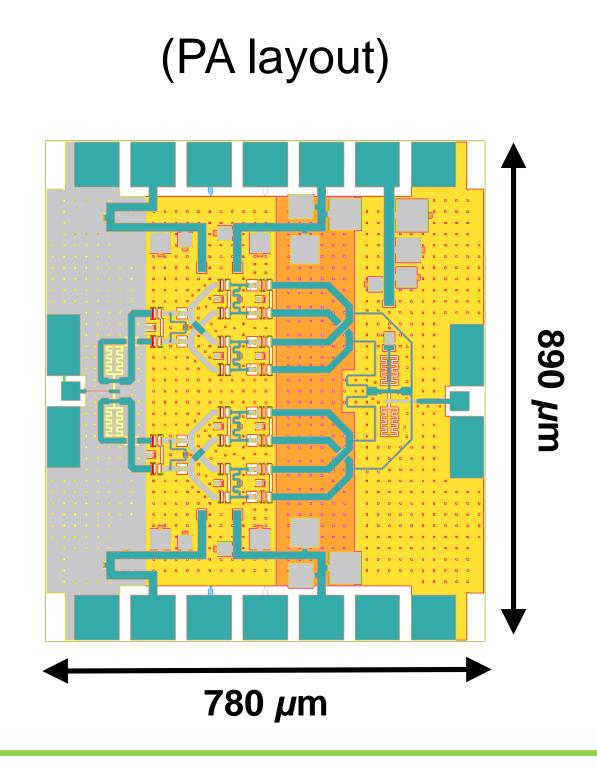
- A differential cascode topology is adopted at the DA and PA units for high small-signal gain and output power.
- A shunt resistor (R<sub>P</sub>) is introduced at the output of the DA unit to improve the stability.





Large-signal simulation

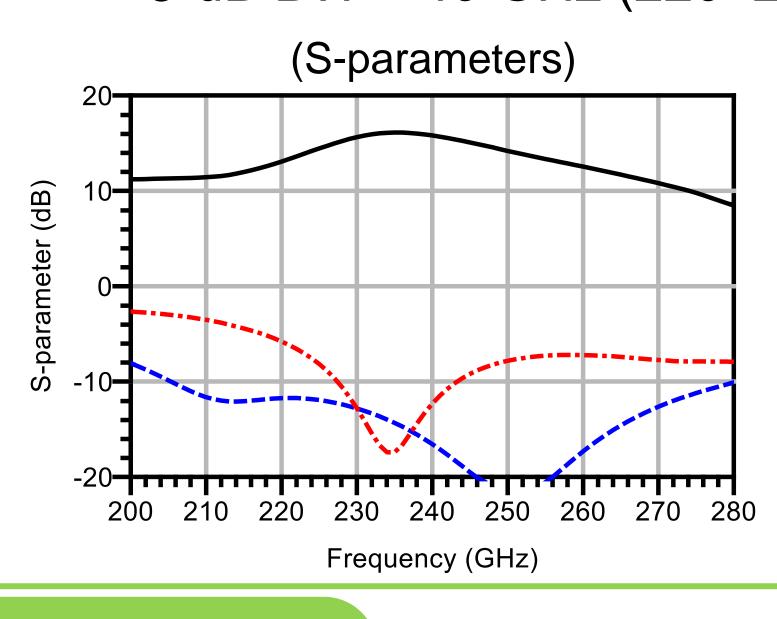
Output power: 14.9 dBm @ 223 GHz

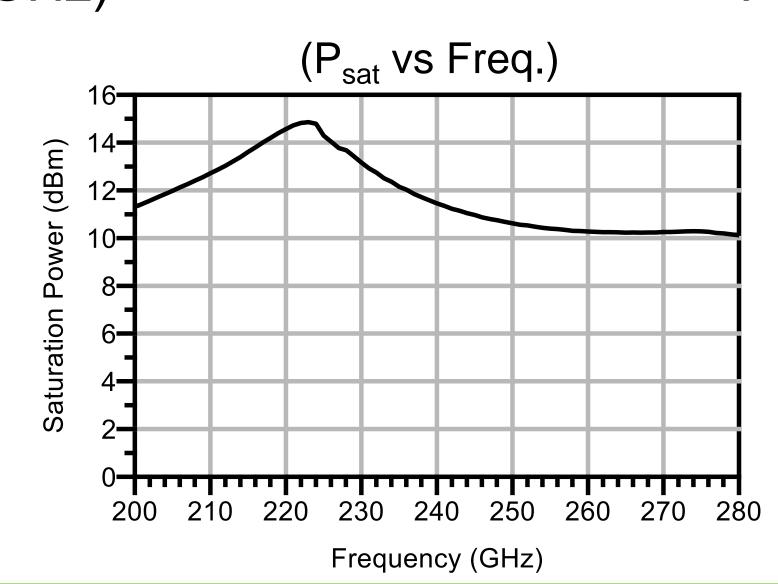


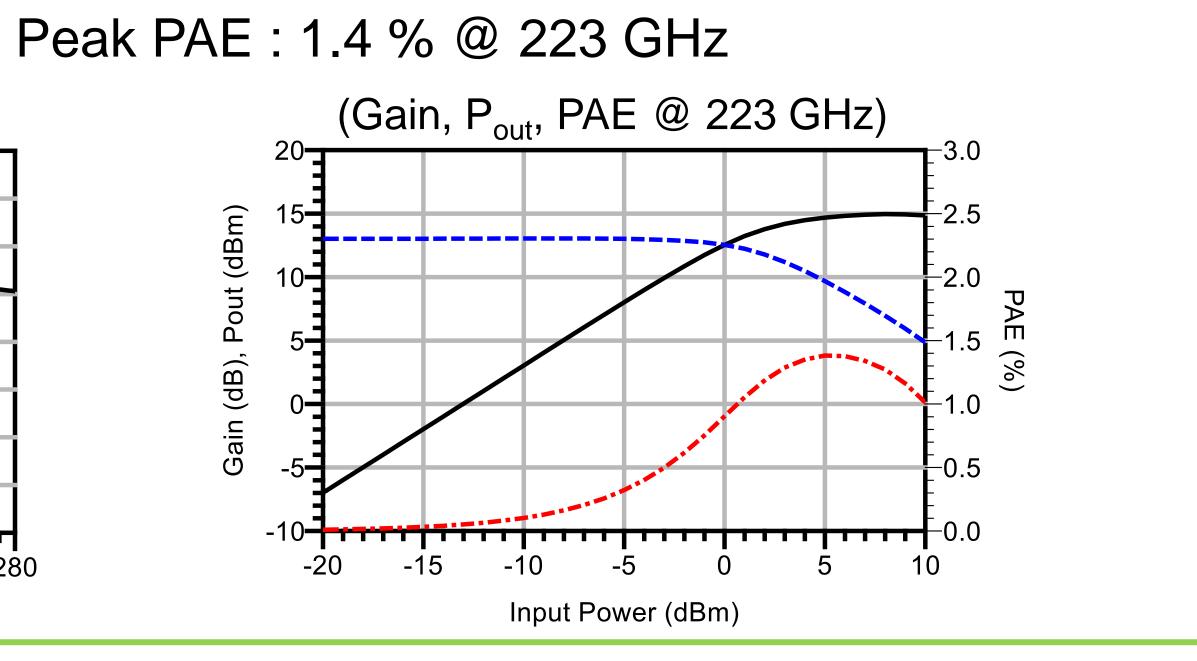
#### Results

#### S-parameters simulation

- Peak  $S_{21} = 16.1 \text{ dB} @ 235 \text{ GHz}$
- 3-dB BW = 40 GHz (220-260 GHz)







### Conclusion

- We have developed a slotline-based power amplifier using the SiGe DHBT process.
- The PA demonstrates high output power, with 14.9 dBm at 223 GHz.

The chip fabrication and EDA tool were supported by the IC Design Education Center(IDEC), Korea